

EconoPIM3 SixPack IGBT Module

$V_{CES}=1700V$, $I_C=75A$, $V_{CE(sat)}=1.9V$

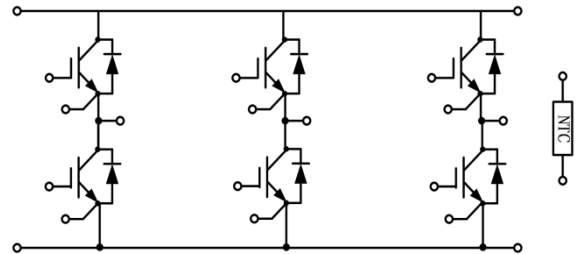
Features

- Low collector to emitter saturation voltage
- Switching-Loss rating includes all “tail” losses
- Optimized for Fast Switching
- Short circuit withstands time (10us min.)
- V_{cesat} with positive Temperature Coefficient



Applications

- Static var generator
- Inverter for motor drive
- High Power Converters



IGBT, Inverter
Maximum Ratings

Parameter	Symbol	Condition	Value	Unit
Collector-emitter voltage	V_{CES}	$T_{vj}=25^{\circ}C$, $V_{GE}=0V$	1700	V
Continuous DC collector current	$I_{C\ nom}$	$T_C=100^{\circ}C$	75	A
Repetitive peak collector current	I_{CRM}	$t_p=1ms$	150	A
Gate-emitter peak voltage	V_{GES}	$T_{vj}=25^{\circ}C$	± 20	V
Maximum Power Dissipation (IGBT)	P_D	$T_C=25^{\circ}C$, $T_J=175^{\circ}C$	555	W
Short Circuit Withstand Time	t_{sc}	$V_{CC}=900V$, $V_{GE}\leq 15V$	10	us

Characteristics Values

Parameter	Symbol	Conditions	Value			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=75A$, $V_{GE}=15V$	$T_{vj}=25^{\circ}C$	1.9		V	
			$T_{vj}=125^{\circ}C$	2.16			
			$T_{vj}=150^{\circ}C$	2.26			
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=1mA$, $V_{CE}=V_{GE}$	$T_{vj}=25^{\circ}C$	5.0	6.0	7.0	V
Input capacitance	C_{ies}	$V_{CE}=25V$, $V_{GE}=0V$, $f=1MHz$	$T_{vj}=25^{\circ}C$		7.5		nF
Reverse transfer capacitance	C_{res}		$T_{vj}=25^{\circ}C$		0.22		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE}=V_{CES}$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$			1.0	mA
Gate-emitter leakage current	I_{GES}	$V_{CE}=0V$, $V_{GE}=20V$	$T_{vj}=25^{\circ}C$			100	nA

Internal Gate Resistance	R_g		$T_{vj}=25^{\circ}\text{C}$		8.1		Ω
Turn-on delay time	$t_{d\ on}$	$V_{CC}=900\text{V},$ $I_C=75\text{A},$ $V_{GE}=\pm 15\text{V},$ $L=525\mu\text{H},$ $R_g=5.6\Omega$	$T_{vj}=25^{\circ}\text{C}$		155		ns
			$T_{vj}=125^{\circ}\text{C}$		175		
			$T_{vj}=150^{\circ}\text{C}$		175		
Rise time	t_r		$T_{vj}=25^{\circ}\text{C}$		61		
			$T_{vj}=125^{\circ}\text{C}$		64		
			$T_{vj}=150^{\circ}\text{C}$		64		
Turn-off delay time	$t_{d\ off}$		$T_{vj}=25^{\circ}\text{C}$		265		
			$T_{vj}=125^{\circ}\text{C}$		290		
			$T_{vj}=150^{\circ}\text{C}$		306		
Fall time	t_f	$T_{vj}=25^{\circ}\text{C}$		568			
		$T_{vj}=125^{\circ}\text{C}$		822			
		$T_{vj}=150^{\circ}\text{C}$		881			
Turn-on energy loss per pulse	E_{on}	$T_{vj}=25^{\circ}\text{C}$		18.2		mJ	
		$T_{vj}=125^{\circ}\text{C}$		22.8			
		$T_{vj}=150^{\circ}\text{C}$		24.8			
Turn-off energy loss per pulse	E_{off}	$T_{vj}=25^{\circ}\text{C}$		14.8			
		$T_{vj}=125^{\circ}\text{C}$		20.9			
		$T_{vj}=150^{\circ}\text{C}$		22.9			

Diode, Inverter Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj}=25^{\circ}\text{C}$	1700	V
Continuous forward current	I_F	$T_C=100^{\circ}\text{C}$	75	A
Repetitive peak forward current	I_{FRM}	$t_p=1\text{ms}$	150	A

Characteristics Values

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F=75\text{A}, V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$	1.6		V
			$T_{vj}=125^{\circ}\text{C}$	1.7		
			$T_{vj}=150^{\circ}\text{C}$	1.7		
Peak reverse recovery current	I_{RM}	$I_F=75\text{A},$ $V_{CC}=900\text{V},$ $V_{GE}=-15\text{V},$ $L=525\mu\text{H}, R_g=5.6\Omega$	$T_{vj}=25^{\circ}\text{C}$	131		A
			$T_{vj}=125^{\circ}\text{C}$	137		
			$T_{vj}=150^{\circ}\text{C}$	143		
Recovered charge	Q_{rr}		$T_{vj}=25^{\circ}\text{C}$	21.0		μC
			$T_{vj}=125^{\circ}\text{C}$	30.6		
			$T_{vj}=150^{\circ}\text{C}$	34.6		
Reverse recovery energy	E_{rec}	$T_{vj}=25^{\circ}\text{C}$	13.3		mJ	
		$T_{vj}=125^{\circ}\text{C}$	19.8			
		$T_{vj}=150^{\circ}\text{C}$	22.4			

NTC Thermistor
Characteristic values

Symbol	Condition	Typ.	Max.	Unit
R ₂₅	T _C =25°C	5		kΩ
ΔR/R	T _C =100°C , R ₁₀₀ =481Ω		±5	%
P ₂₅	T _C =25°C	50		mW
B _{25/50}	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15K))]$	3380		K
B _{25/80}	$R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15K))]$	3440		K

Module
Characteristics Values

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Isolation test voltage	V _{ISOL}	RMS, f=50Hz, t=1min		4		kV
Maximum Junction Temperature	T _J				175	°C
Maximum Operating Junction Temperature Range	T _{JOP}		-40		+150	°C
Storage temperature	T _{stg}		-40		+150	°C
Junction-to-Case (per IGBT) Junction-to-Case (per Diode)	R _{thJC}			0.27 0.47		K/W
Case-to-Heatsink (per IGBT) Case-to-Heatsink (per Diode) Case-to-Heatsink (per Module)	R _{thCH}			0.11 0.18 0.01		K/W
Mounting torque for module mounting	M		3	-	6	N·m
Weight	G			300		g

Typical Characteristics

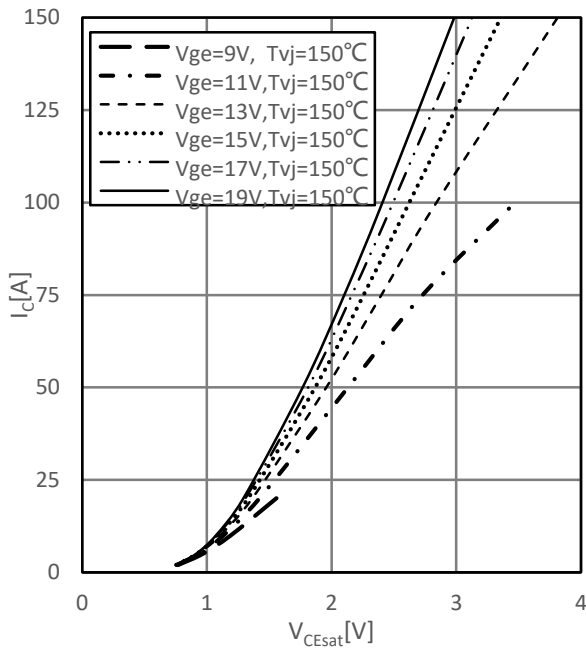


Fig.1 output characteristic IGBT Inverter (typical)

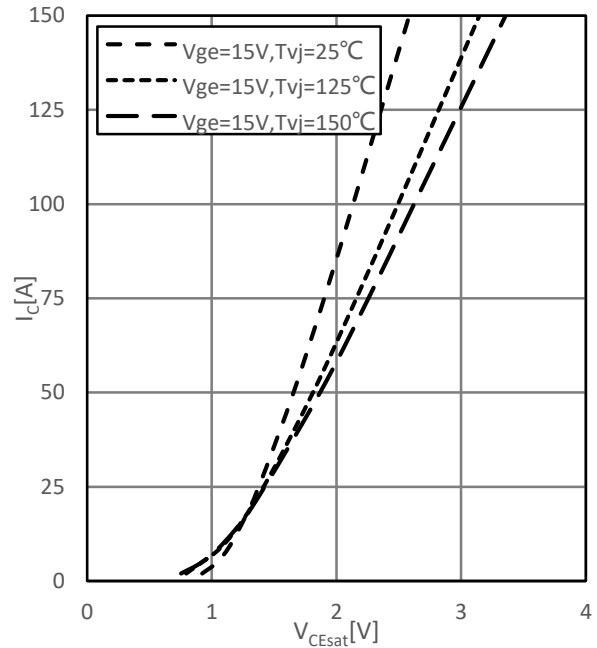


Fig.2 output characteristic IGBT Inverter (typical)

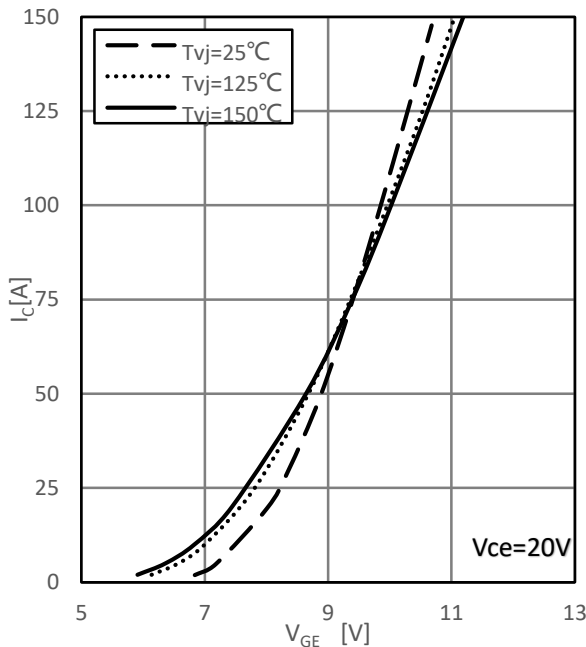


Fig.3 transfer characteristic IGBT Inverter (typical)

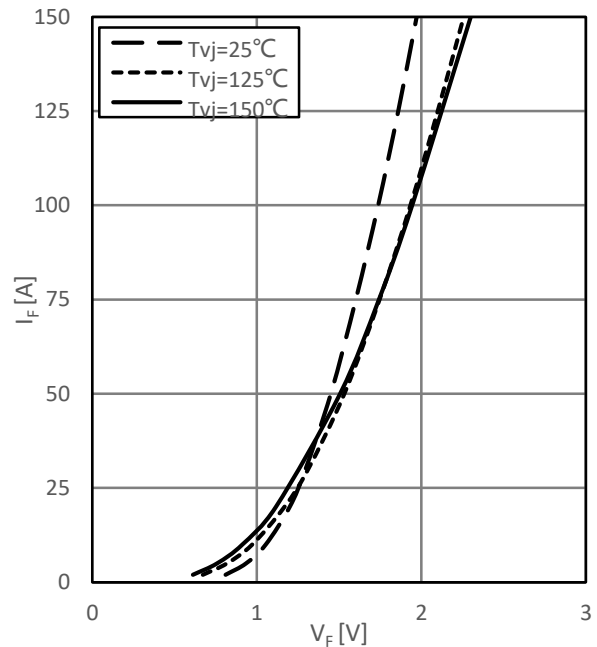


Fig.4 forward characteristic of Diode, Inverter (typical)

$V_{CC}=900V$, $V_{CE}=\pm 15V$
 $R_G=5.6\Omega$

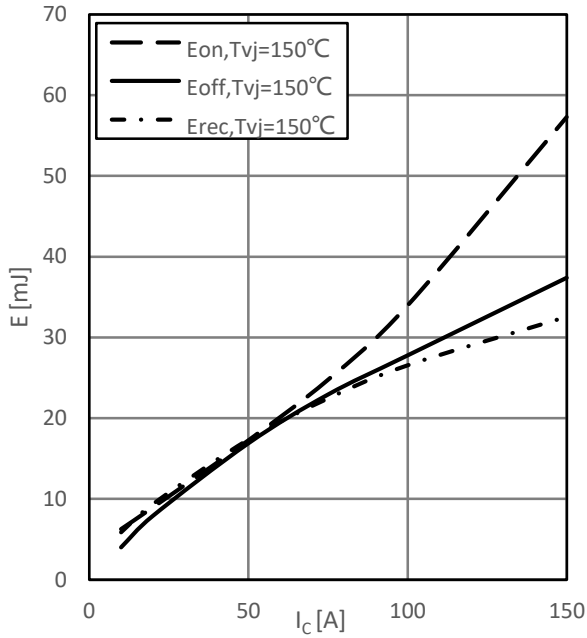


Fig.5 switching losses IGBT Inverter (typical)

$V_{CC}=900V$, $V_{CE}=\pm 15V$
 $I_c=75A$

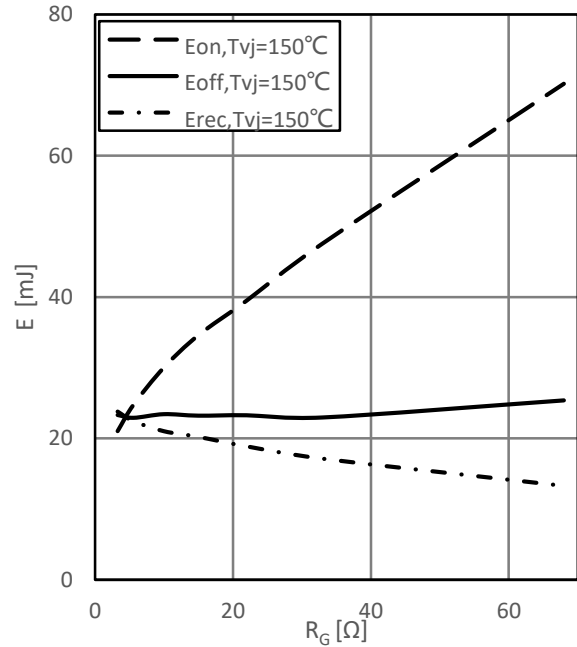


Fig.6 switching Losses vs. Gate Resistance (Typical)

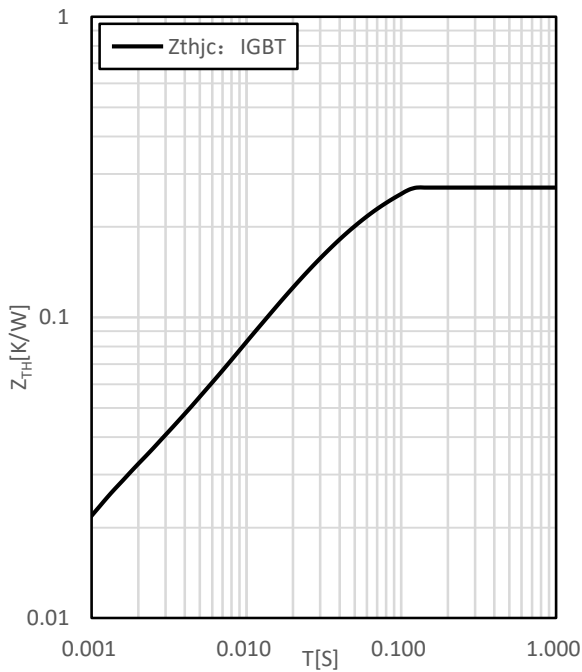


Fig.7 Transient thermal impedance IGBT

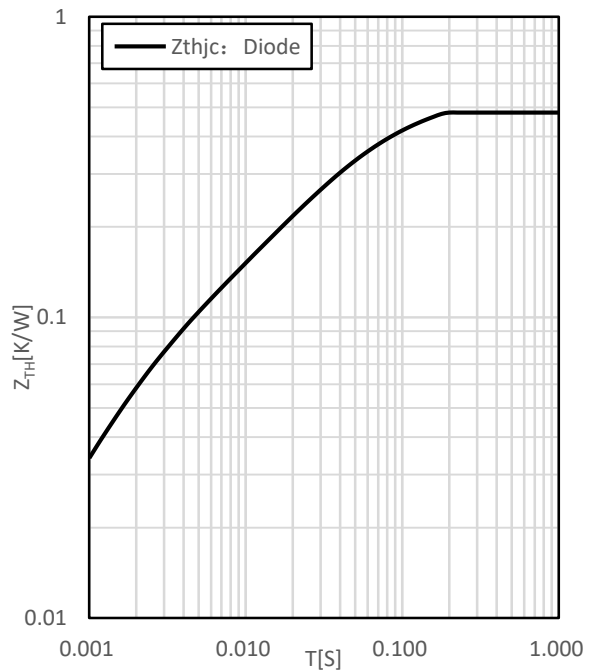


Fig.8 Transient thermal impedance Diode

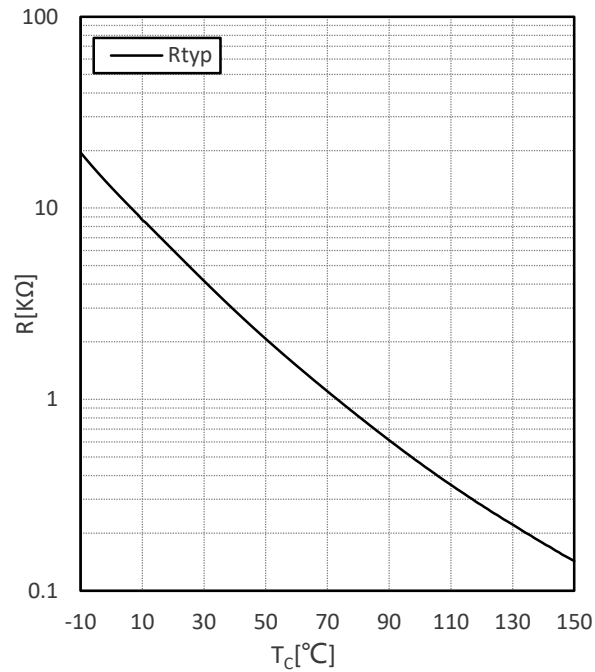
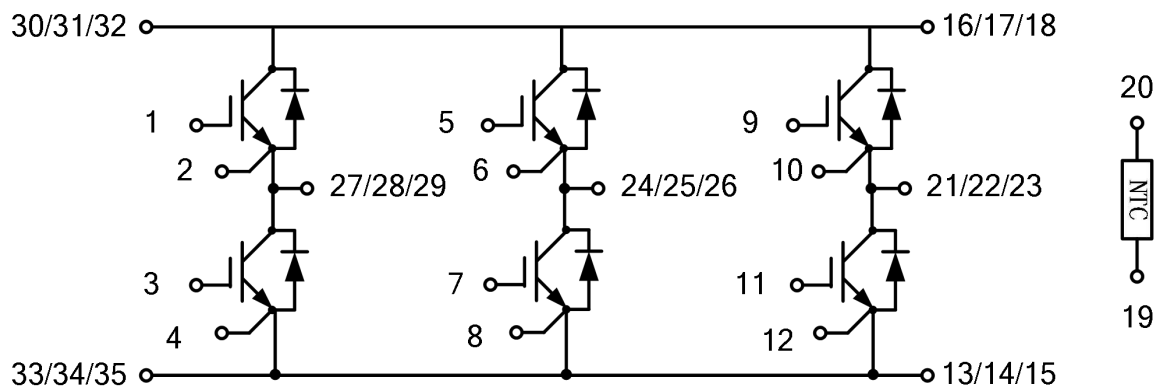
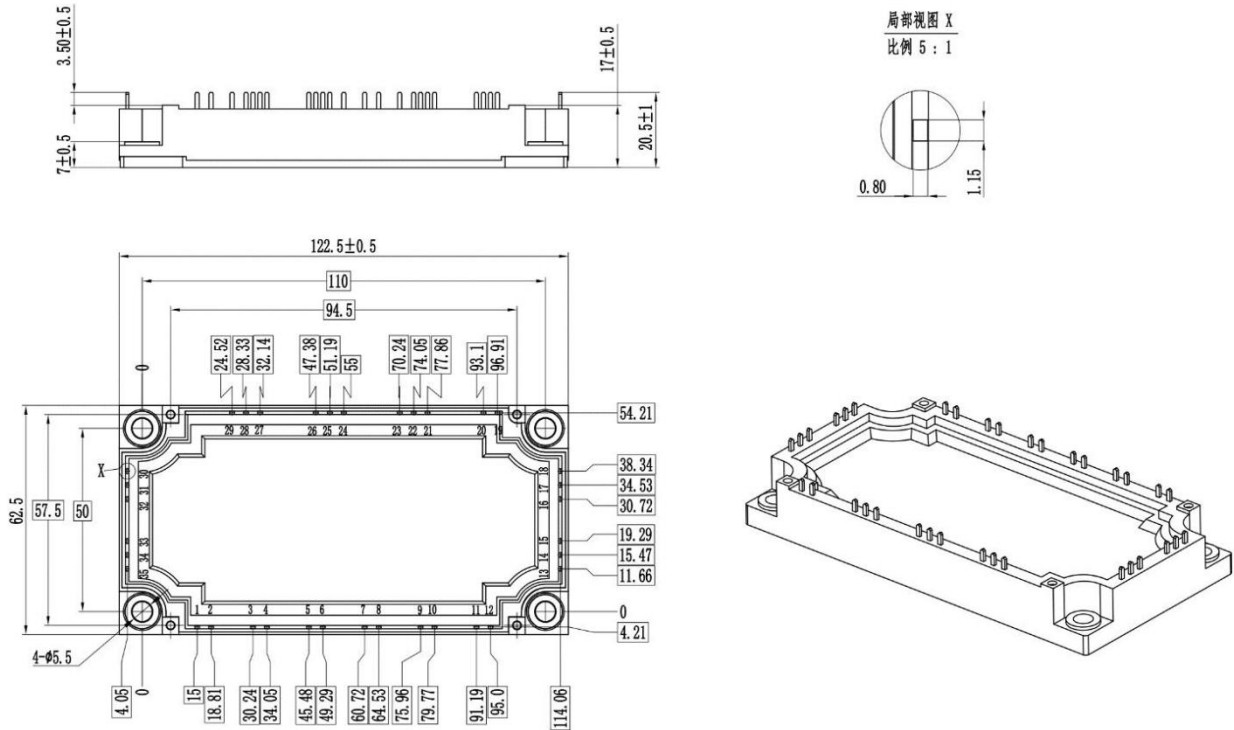


Fig.9 NTC Temperature characteristics

Circuit Diagram



Package Outlines (Unit:mm)



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